



TSMC00-079

1765
#5/A
10/18/02
December 3 2001

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

ATTN: GROUP ART UNIT 1765 L. VINH

FR: Stephen B. Ackerman Reg. No. 37761
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JAN 16 2002
TC 1700

Subject:

Serial No. 09/579,542	05/26/00
Cheng Chung Lin and Lain-Jong Li	
"Method to improve stability and reliability of CVD low k dielectric"	
Grp. Art Unit :1765	L. Vinh

RESPONSE TO PATENT OFFICE ACTION

Dear Sir:

In response to the Office Action dated September 24 2001, in the above identified application for patent, please enter the following amendments and consider the following remarks.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on December 19 2001.

Name Stephen B. Ackerman, Reg #37,761

Signature/Date SS DL 10/19/01